40 V, 2.0 A, Low V_{CE(sat)} PNP Transistor

ON Semiconductor's e^2 PowerEdge family of low V_{CE(sat)} transistors are miniature surface mount devices featuring ultra low saturation voltage (V_{CE(sat)}) and high current gain capability. These are designed for use in low voltage, high speed switching applications where affordable efficient energy control is important.

Typical applications are DC–DC converters and power management in portable and battery powered products such as cellular and cordless phones, PDAs, computers, printers, digital cameras and MP3 players. Other applications are low voltage motor controls in mass storage products such as disc drives and tape drives. In the automotive industry they can be used in air bag deployment and in the instrument cluster. The high current gain allows e²PowerEdge devices to be driven directly from PMU's control outputs, and the Linear Gain (Beta) makes them ideal components in analog amplifiers.

Features

- NSV Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC–Q101 Qualified and PPAP Capable
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

MAXIMUM RATINGS ($T_A = 25^{\circ}C$)

Rating	Symbol	mbol Max	
Collector-Emitter Voltage	V _{CEO}	-40	Vdc
Collector-Base Voltage	V _{CBO}	-40	Vdc
Emitter-Base Voltage	V _{EBO}	-7.0	Vdc
Collector Current – Continuous	Ι _C	-2.0	Adc
Collector Current – Peak	I _{CM}	-4.0	A
Electrostatic Discharge	ESD	HBM Cla MM Cla	

THERMAL CHARACTERISTICS

Characteristic	Symbol	Мах	Unit	
Total Device Dissipation, $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D (Note 1)	875 7.0	mW mW/°C	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 1)	143	43 °C/W	
Total Device Dissipation, $T_A = 25^{\circ}C$ Derate above $25^{\circ}C$	P _D (Note 2)	1.5 11.8		
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$ (Note 2)	85	°C/W	
Thermal Resistance, Junction–to–Lead #1	$R_{\theta JL}$ (Note 2)	23	°C/W	
Total Device Dissipation (Single Pulse < 10 sec)	P _{Dsingle} (Notes 2 & 3)	3.0	W	
Junction and Storage Temperature Range	T _J , T _{stg}	–55 to +150	°C	

1. FR-4 @ 100 mm², 1 oz copper traces.

2. FR-4 @ 500 mm², 1 oz copper traces.

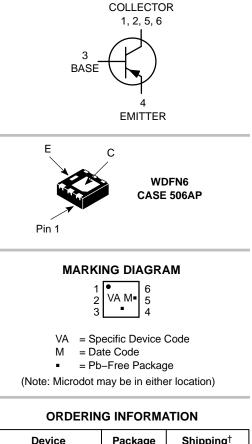
3. Thermal response.



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$\begin{array}{c} -40 \text{ VOLTS} \\ 2.0 \text{ AMPS} \end{array} \\ \textbf{PNP LOW V}_{\text{CE(sat)}} \text{ TRANSISTOR} \\ \textbf{EQUIVALENT R}_{\text{DS(on)}} 100 \text{ m}\Omega \end{array}$



Device	Package	Shipping [†]
NSS40200UW6T1G	WDFN6 (Pb-Free)	3000/ Tape & Reel
NSV40200UW6T1G	WDFN6 (Pb-Free)	3000/ Tape & Reel

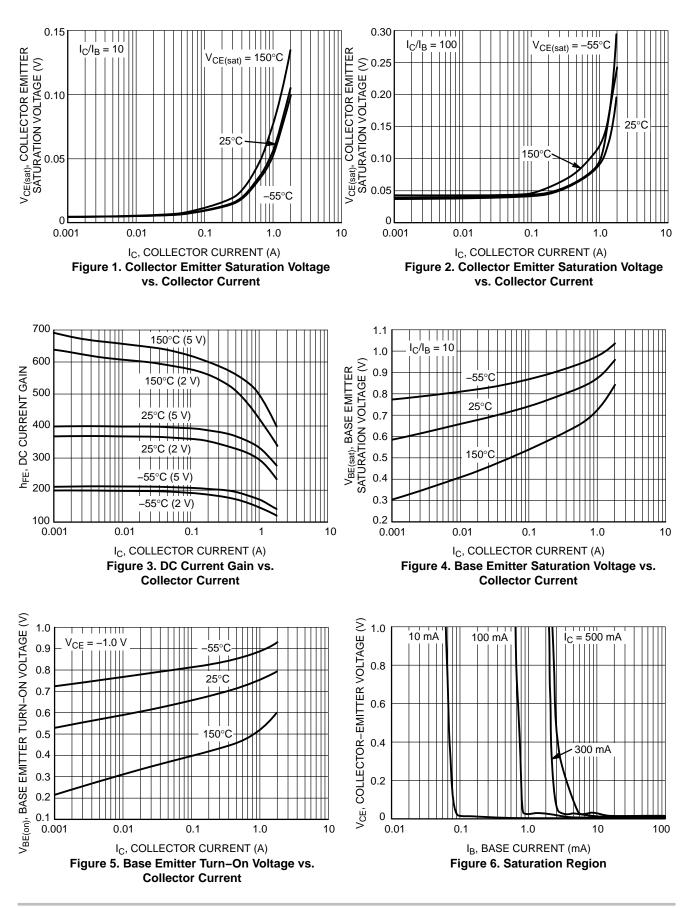
[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

ELECTRICAL CHARACTERISTICS (T_A = 25°C unless otherwise noted)

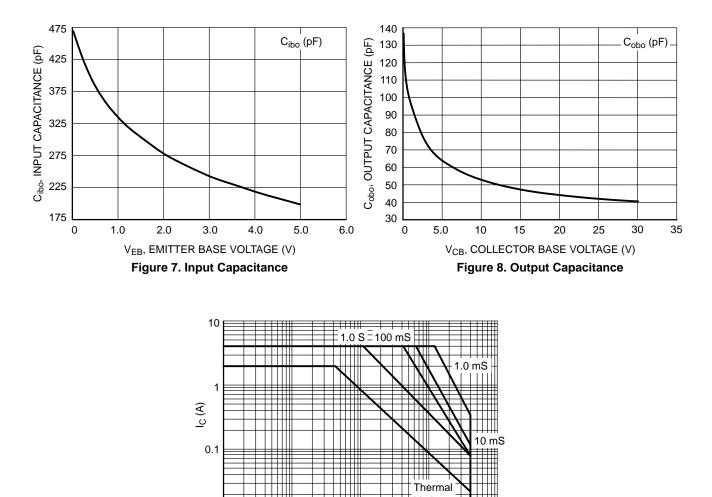
Characteristic	Symbol	Min	Typical	Max	Unit
OFF CHARACTERISTICS				•	
Collector – Emitter Breakdown Voltage ($I_C = -10 \text{ mAdc}, I_B = 0$)	V _{(BR)CEO}	-40	-	_	Vdc
Collector – Base Breakdown Voltage ($I_C = -0.1 \text{ mAdc}, I_E = 0$)	V _{(BR)CBO}	-40	-	_	Vdc
Emitter-Base Breakdown Voltage ($I_E = -0.1 \text{ mAdc}, I_C = 0$)	V _{(BR)EBO}	-7.0	_	_	Vdc
Collector Cutoff Current ($V_{CB} = -40 \text{ Vdc}, I_E = 0$)	I _{CBO}	_	-	-0.1	μAdc
Emitter Cutoff Current (V _{EB} = -7.0 Vdc)	I _{EBO}	_	_	-0.1	μAdc
ON CHARACTERISTICS			-		
DC Current Gain (Note 4) ($I_C = -10 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -500 \text{ mA}, V_{CE} = -2.0 \text{ V}$) ($I_C = -1.0 \text{ A}, V_{CE} = -2.0 \text{ V}$) ($I_C = -2.0 \text{ A}, V_{CE} = -2.0 \text{ V}$)	h _{FE}	150 150 150 150		- - - -	
Collector – Emitter Saturation Voltage (Note 4) ($I_{C} = -0.1 \text{ A}, I_{B} = -0.010 \text{ A}$) (Note 5) ($I_{C} = -1.0 \text{ A}, I_{B} = -0.100 \text{ A}$) ($I_{C} = -1.0 \text{ A}, I_{B} = -0.010 \text{ A}$) ($I_{C} = -2.0 \text{ A}, I_{B} = -0.020 \text{ A}$)	V _{CE(sat)}	- - -	 	-0.020 -0.120 -0.200 -0.300	V
Base – Emitter Saturation Voltage (Note 4) ($I_C = -1.0 \text{ A}, I_B = -0.01 \text{ A}$)	V _{BE(sat)}	_	-0.76	-0.900	V
Base – Emitter Turn–on Voltage (Note 4) ($I_C = -2.0 \text{ A}, V_{CE} = -3.0 \text{ V}$)	V _{BE(on)}	_	-0.80	-0.900	V
Cutoff Frequency (I _C = -100 mA, V _{CE} = -5.0 V, f = 100 MHz)	f _T	140	_	-	MHz
Input Capacitance (V _{EB} = -0.5 V, f = 1.0 MHz)	Cibo	-		500	pF
Output Capacitance ($V_{CB} = -3.0 \text{ V}, f = 1.0 \text{ MHz}$)	Cobo	_		100	pF
SWITCHING CHARACTERISTICS					
Delay (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA)	t _d	-	-	70	ns
Rise (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA)	t _r	-	-	150	ns
Storage (V_{CC} = 30 V, I_{C} = 750 mA, I_{B1} = 15 mA)	t _s	_	-	525	ns
Fall (V _{CC} = 30 V, I _C = 750 mA, I _{B1} = 15 mA)	t _f	-	-	155	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.
4. Pulsed Condition: Pulse Width = 300 μsec, Duty Cycle ≤ 2%.
5. Guaranteed by design but not tested.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS



1

 V_{CE} (V_{dc}) Figure 9. PNP Safe Operating Area

0.1

0.01 0.01 Thermal

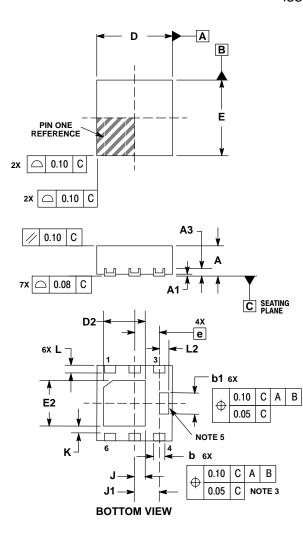
10

100

Limit

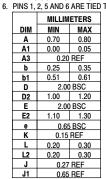
PACKAGE DIMENSIONS

WDFN6 2x2 CASE 506AP **ISSUE B**

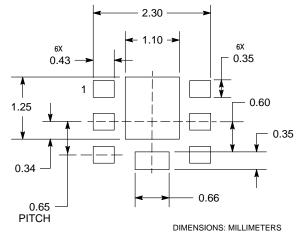


NOTES 1. DIMENSIONING AND TOLERANCING PER ASME

- Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS. 2
- DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.20mm FROM 3. TERMINAL
- COPLANARITY APPLIES TO THE EXPOSED PAD AS 4 WELL AS THE TERMINALS. CENTER TERMINAL LEAD IS OPTIONAL. TERMINAL
- 5.
 - LEAD IS CONNECTED TO TERMINAL LEAD # 4 PINS 1, 2, 5 AND 6 ARE TIED TO THE FLAG.



SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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